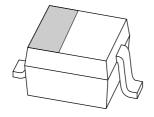
## **DISCRETE SEMICONDUCTORS**

## DATA SHEET



# **BAP51-03**General purpose PIN diode

Product specification Supersedes data of 1999 Aug 16 2004 Feb 11





**Philips Semiconductors** 

## **General purpose PIN diode**

**BAP51-03** 

## **FEATURES**

- Low diode capacitance
- Low diode forward resistance.

## **APPLICATIONS**

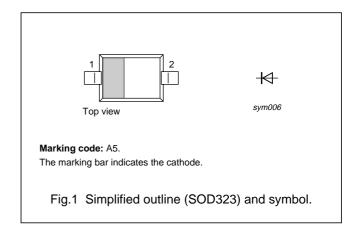
· General RF applications.

## **DESCRIPTION**

General purpose PIN diode in a SOD323 small plastic SMD package.

## **PINNING**

PIN	DESCRIPTION
1	cathode
2	anode



## **ORDERING INFORMATION**

TYPE		PACKAGE				
NUMBER	NAME	DESCRIPTION VERS				
BAP51-03	_	plastic surface mounted package; 2 leads	SOD323			

## **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_R$	continuous reverse voltage		_	50	V
I <sub>F</sub>	continuous forward current		_	50	mA
P <sub>tot</sub>	total power dissipation	T <sub>S</sub> = 90 °C	_	500	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>j</sub>	junction temperature		-65	+150	°C

Philips Semiconductors Product specification

## General purpose PIN diode

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## **ELECTRICAL CHARACTERISTICS**

 $T_i = 25$  °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 50 mA	_	0.95	1.1	V
V <sub>R</sub>	reverse voltage	I <sub>R</sub> = 10 μA	50	_	_	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 50 V	_	_	100	nA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 0; f = 1 MHz	_	0.4	_	pF
		V <sub>R</sub> = 1 V; f = 1 MHz	_	0.3	0.55	pF
		V <sub>R</sub> = 5 V; f = 1 MHz	_	0.2	0.35	pF
r <sub>D</sub>	diode forward resistance	I <sub>F</sub> = 0.5 mA; f = 100 MHz; note 1	_	5.5	9	Ω
		I <sub>F</sub> = 1 mA; f = 100 MHz; note 1	_	3.6	6.5	Ω
		I <sub>F</sub> = 10 mA; f = 100 MHz; note 1	_	1.5	2.5	Ω
τ∟	charge carrier life time	when switched from $I_F$ = 10 mA to $I_R$ = 6 mA; $R_L$ = 100 $\Omega$ ; measured at $I_R$ = 3 mA	_	550	_	ns

## Note

1. Guaranteed on AQL basis: inspection level S4, AQL 1.0.

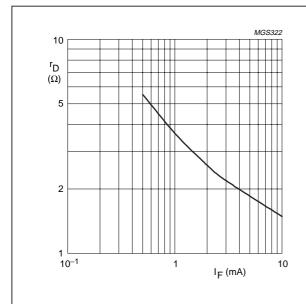
## THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R <sub>th(j-s)</sub>	thermal resistance from junction to soldering point		K/W

## General purpose PIN diode

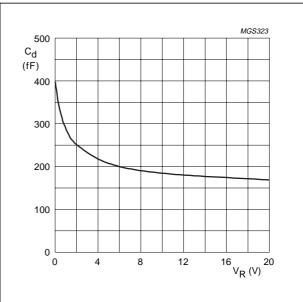
**BAP51-03** 

## **GRAPHICAL DATA**



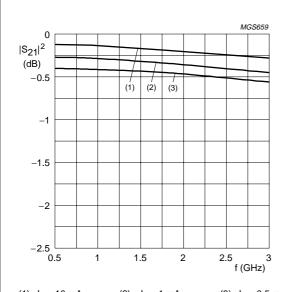
 $T_i = 25 \,^{\circ}\text{C}$ ; f = 100 MHz.

Fig.2 Forward resistance as a function of forward current; typical values.



 $T_j = 25$  °C; f = 1 MHz.

Fig.3 Diode capacitance as a function of reverse voltage; typical values.



(1)  $I_F = 10 \text{ mA}.$ 

(2)  $I_F = 1 \text{ mA}.$ 

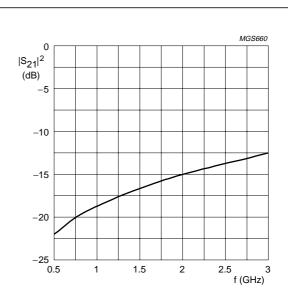
(3)  $I_F = 0.5 \text{ mA}.$ 

4

Diode inserted in series with a 50  $\Omega$  stripline circuit and biased via the analyzer Tee network.

 $T_{amb} = 25 \, ^{\circ}C.$ 

Fig.4 Insertion loss ( $|S_{21}|^2$ ) of the diode as a function of frequency; typical values.



Diode zero biased and inserted in series with a 50  $\Omega$  stripline circuit.  $T_{amb}$  = 25  $^{\circ}C.$ 

Fig.5 Isolation ( $|S_{21}|^2$ ) of the diode as a function of frequency; typical values.

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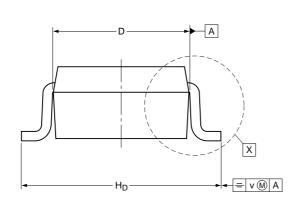
## General purpose PIN diode

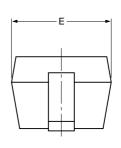
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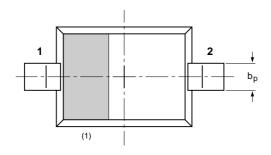
## **PACKAGE OUTLINE**

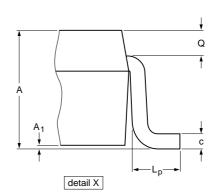
Plastic surface mounted package; 2 leads

SOD323











## DIMENSIONS (mm are the original dimensions)

UNIT	Α	A <sub>1</sub> max	bp	С	D	E	H <sub>D</sub>	Lp	Q	v
mm	1.1 0.8	0.05	0.40 0.25	0.25 0.10	1.8 1.6	1.35 1.15	2.7 2.3	0.45 0.15		0.2

#### Note

1. The marking bar indicates the cathode

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOD323			SC-76			<del>-99-09-13</del> 03-12-17

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## General purpose PIN diode

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#### **DATA SHEET STATUS**

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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